

SPV1002

Cool bypass switch for photovoltaic applications

Features

- I_F = 16 A, V_R = 40 V
- Very low forward voltage drop
- Very low reverse leakage current
- 175 °C operating junction temperature

Applications

Photovoltaic panels

Description

The SPV1002 is a system-in-package solution for photovoltaic applications to perform cool bypass rectification similar to that of a conventional Schottky diode but with much lower forward voltage drop and reverse leakage current.

The device consists of a power MOSFET transistor which charges a capacitor during the OFF time, and drives its gate during the ON time using the charge previously stored in the capacitor.

The ON and OFF times are set to reduce the average voltage drop across the drain and source terminals, resulting in reduced power dissipation.

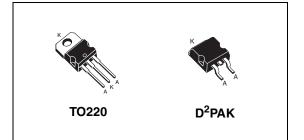


Table 1.	Device summary

Order codes	Package	Packaging
SPV1002D40	D ² PACK	Tube
SPV1002T40	TO220	Tube
SPV1002D40TR	D ² PACK	Tape and reel

1 Maximum ratings

1.1 Absolute maximum ratings

Symbol	Parameter	Range [min, max]	Unit
V _R	Max DC reverse voltage	40	V
١ _F	Max forward current	16	А
I _{FSM}	Non repetitive peak surge (half-wave, single-phase, 60 Hz)	250	А
ESD level	Human body level	≥ 8 k	V
R _{thJC}	Thermal resistance, junction-to-ambient (D ² PAK, TO220)	1.6	°C/W
Т _Ј	Junction temperature operating range -40 to 175		°C
T _{STG}	Storage temperature range	-40 to 175	°C

Table 2. Absolute maximum ratings



2 Electrical characteristics

		-		-			
Cumbal	Parameter	Test condition		Values			
Symbol				Min	Тур	Max	Unit
V _{F,AVG}	AVG forward voltage drop	IF = 16A ⁽¹⁾	$T_J = 25^{\circ}C$	-	180	-	mV
		IF = 8A ⁽¹⁾	$T_J = 25^{\circ}C$	-	110	-	mV
			T _J = 125 °C	-	230	-	mV
I _R	Reverse leakage current	VR = 40V	$T_J = 25^{\circ}C$	-	1	-	μA
			T _J = 125°C	-	10	-	μA
D	TON/T ratio	IF = 8A ⁽¹⁾	$T_J = 25^{\circ}C$	-	95%	-	-
			T _J = 125°C	-	75%	-	-
V _F	Forward voltage drop	IF = 8A, T _{OFF}	TJ = 25°C	-	850	-	mV
			T _J = 125°C	-	600	-	mV
		IF = 8A ⁽¹⁾ , T _{ON}	$T_J = 25^{\circ}C$	-	60	-	mV
		11 - 07 °, 10N	T _J = 125°C	-	120	-	mV

Table 3.Electrical characteristics

1. For correct power dissipation and heatsink sizing, please refer to *Figure 1*, 4 and 5.



3 Device description

A photovoltaic panel consists of a series of PV cells. In optimal conditions, all the cells are equally irradiated and function at the same current level. However, during normal operation some cells may become partially shaded or obscured. These shaded cells limit the current generated by the fully irradiated cells and, in the extreme cases where these cells are totally obscured, the current flow is blocked.

In this case the shaded cells behave like a load, and the current generated from the fully irradiated cells produces overvoltages which can reach the breakdown threshold. This phenomenon, known as a "hot spot", can cause overheating of the shaded cells and, in some cases, even permanent damage resulting in current leakage. To prevent hot spots, therefore, bypass diodes are connected in parallel to the cell strings.

The device described here has the same functionality as a Schottky diode, but with improved performance. It features very low forward voltage drop and reverse leakage current. It consists of a power MOSFET transistor which charges a capacitor during the OFF time, and drives its gate during the ON time using the charge previously stored in the capacitor. The ON and OFF times are set to reduce the average voltage drop across the drain and source terminals, resulting in reduced power dissipation.

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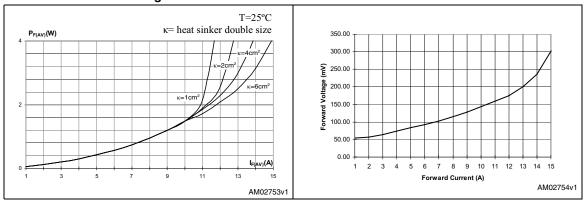
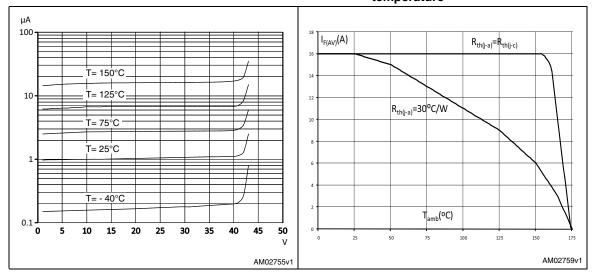


Figure 1. Average forward power dissipation Figure 2. Forward voltage versus average forward current



Figure 4. Average current versus ambient temperature





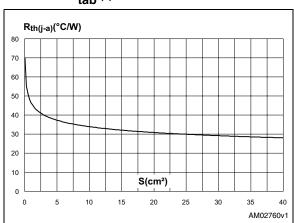


Figure 5. Thermal resistance junction-toambient vs copper surface under tab ⁽¹⁾

1. Epoxy printed board FR4, Cu = 35 μm

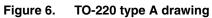
4 Package mechanical data

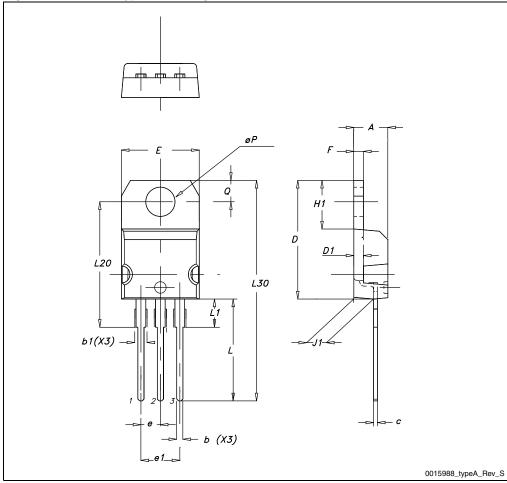
In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

Dim.		mm	
	Min.	Тур.	Max.
А	4.40		4.60
b	0.61		0.88
b1	1.14		1.70
с	0.48		0.70
D	15.25		15.75
D1		1.27	
E	10	10.40	
е	2.40	2.70	
e1	4.95	5.15	
F	1.23	1.32	
H1	6.20		6.60
J1	2.40		2.72
L	13		14
L1	3.50		3.93
L20		16.40	
L30		28.90	
ØР	3.75		3.85
Q	2.65		2.95

Table 4.TO-220 type A mechanical data









able 5.	D ² PAK (10-263) mechanic				
Dim.		mm			
	Min.	Тур.	Max.		
А	4.40		4.60		
A1	0.03		0.23		
b	0.70		0.93		
b2	1.14		1.70		
С	0.45		0.60		
c2	1.23		1.36		
D	8.95		9.35		
D1	7.50				
E	10		10.40		
E1	8.50				
е		2.54			
e1	4.88		5.28		
Н	15		15.85		
J1	2.49		2.69		
L	2.29		2.79		
L1	1.27		1.40		
L2	1.30		1.75		
R		0.4			
V2	0°		8°		

 Table 5.
 D²PAK (TO-263) mechanical data



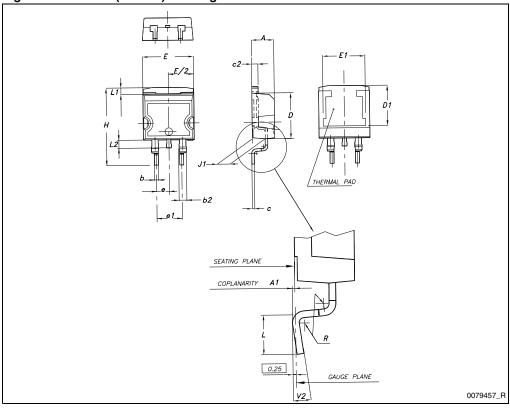


Figure 7. D²PAK (TO-263) drawing

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5 Revision history

Table 6. Document revision history

Date	Revision	Changes
16-May-2011	1	Initial release
16-Jun-2011	2	 Added D²PAK package Minor text changes
17-Nov-2011	3	Updated Figure 3



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